

IN THE CLAIMS:

Please amend Claims 22, 28 and 29 as follows. Note all the claims currently pending in this application, including those not presently amended, have been reproduced below for the Examiner's convenience.

Claims 1-21. (Canceled)

22. (Currently Amended) A pod for attachment to an outside surface of a grounded electromagnetic-shielded chamber having a door and a grounded flange portion, around the door, on the outside surface and containing a device manufacturing apparatus for processing a substrate, said pod comprising:

walls for containing ~~[[a]]~~ the substrate; and

a lid for an opening, defined by the said walls, for transferring through which the substrate is transferred between said pod and the grounded electromagnetic-shielded chamber,

wherein said walls comprise an electromagnetic shield member, said electromagnetic shield member including a flange portion to be in contact with the grounded flange portion of the grounded electromagnetic-shielded chamber during the attachment of said pod to the ~~grounded electromagnetic-shielded chamber~~ outside surface.

23. (Previously Presented) A pod according to Claim 22, wherein said lid is arranged in front of said pod.

24. (Previously Presented) A pod according to Claim 22, wherein said lid is arranged in a bottom of said pod.

25. (Previously Presented) A pod according to Claim 22, wherein said electromagnetic shield member comprises wire mesh arranged on or within said walls.

26. (Previously Presented) A pod according to Claim 22, wherein said electromagnetic shield member comprises metal coatings arranged on said walls.

27. (Previously Presented) A pod according to Claim 22, wherein said electromagnetic shield member comprises electromagnetic-shield materials arranged in said walls.

28. (Currently Amended) ~~An~~ A device manufacturing apparatus for ~~manufacturing a device using~~ for processing a substrate, said apparatus comprising:

an electromagnetic-shielded chamber;

a transfer unit, in said electromagnetic-shielded chamber, ~~for transferring to~~ transfer the substrate between said electromagnetic shielded chamber and a pod attached to an

outside surface of said electromagnetic-shielded chamber and having an electromagnetic shield member which includes a flange portion to contact the outside surface; and

a processing unit, in said electromagnetic shielded chamber, for performing a
to process using the substrate transferred into said electromagnetic-shielded chamber from the
pod by said transfer unit,

wherein said electromagnetic-shielded chamber has a door and a grounded
flange portion, around said door, on the outside surface to provide a grounded connection
between said grounded flange portion to the attached and the flange portion of the pod during
attachment of the pod to the outside surface.

29. Currently Amended) An apparatus according to claim 28, wherein ~~said electromagnetic-shielded chamber comprises a door through which said transfer unit transfers the~~
substrate between said electromagnetic-shielded chamber and the pod through, said grounded
~~portion is arranged around said door.~~

30. (Previously Presented) An apparatus according to 28, wherein said
processing unit exposes the substrate to a pattern.

31. (Previously Presented) An apparatus according to Claim 28, wherein a lid of
the pod is arranged in front of the pod.

32. (Previously Presented) An apparatus according to Claim 28, wherein a lid of the pod is arranged in a bottom of the pod.

33. (Previously Presented) An apparatus according to Claim 28, wherein walls of the pod comprises the electromagnetic shield member.

Claims 34 through 40 (Canceled)